

SN74ALVCH162525

18-BIT REGISTERED BUS TRANSCEIVER WITH 3-STATE OUTPUTS

SCES058F – NOVEMBER 1995 – REVISED SEPTEMBER 1999

- Member of the Texas Instruments *Widebus™* Family
- *EPIC™* (Enhanced-Performance Implanted CMOS) Submicron Process
- B-Port Outputs Have Equivalent 26-Ω Series Resistors, So No External Resistors Are Required
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Package Option Includes Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages

NOTE: For tape and reel order entry:
The DGGR package is abbreviated to GR.

description

This 18-bit universal bus transceiver is designed for 1.65-V to 3.6-V V_{CC} operation.

Data flow in each direction is controlled by output-enable (\overline{OEAB} and \overline{OEBA}) and clock-enable ($\overline{CLKENAB}$ and $\overline{CLKENBA}$) inputs. For the A-to-B data flow, the data flows through a single register. The B-to-A data can flow through a four-stage pipeline register path, or through a single register path, depending on the state of the select (\overline{SEL}) input.

Data is stored in the internal registers on the low-to-high transition of the clock (CLK) input, provided that the appropriate \overline{CLKEN} inputs are low. The A-to-B data transfer is synchronized to the CLKAB input, and B-to-A data transfer is synchronized with the CLK1BA and CLK2BA inputs.

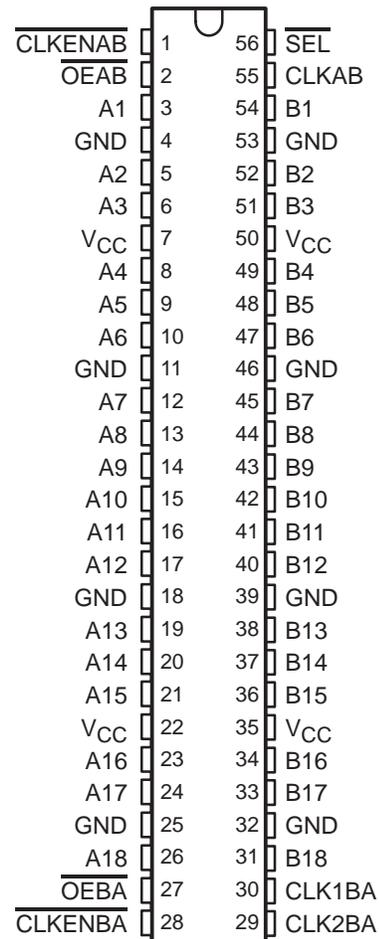
The B outputs, which are designed to sink up to 12 mA, include equivalent 26-Ω resistors to reduce overshoot and undershoot.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The SN74ALVCH162525 is characterized for operation from -40°C to 85°C.

DGG OR DL PACKAGE
(TOP VIEW)



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

EPIC and Widebus are trademarks of Texas Instruments Incorporated.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 1999, Texas Instruments Incorporated

SN74ALVCH162525
18-BIT REGISTERED BUS TRANSCEIVER
WITH 3-STATE OUTPUTS

SCES058F – NOVEMBER 1995 – REVISED SEPTEMBER 1999

Function Tables

A-TO-B STORAGE
($\overline{OEAB} = L$)

INPUTS			OUTPUT B
$\overline{CLKENAB}$	CLKAB	A	
H	X	X	B_0^\dagger
L	↑	L	L
L	↑	H	H

† Output level before the indicated steady-state input conditions were established

B-TO-A STORAGE
($\overline{OEBA} = L$)

INPUTS					OUTPUT A
$\overline{CLKENBA}$	CLK2BA	CLK1BA	\overline{SEL}	B	
H	X	X	X	X	A_0^\dagger
L	↑	X	H	L	L
L	↑	X	H	H	H
L	↑	↑	L	L	L^\ddagger
L	↑	↑	L	H	H^\ddagger

† Output level before the indicated steady-state input conditions were established

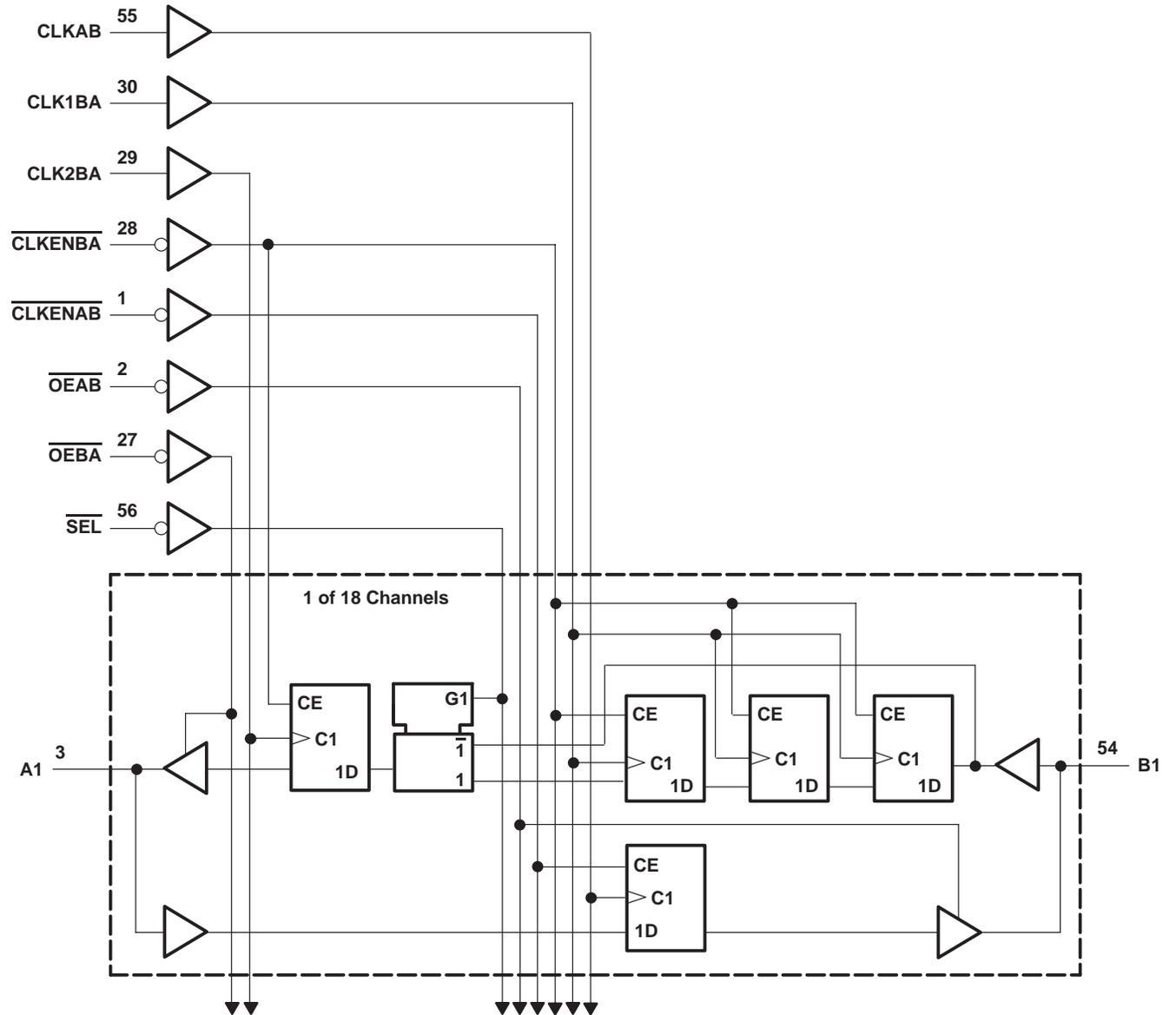
‡ Three CLK1BA edges and one CLK2BA edge are needed to propagate data from B to A when \overline{SEL} is low.



SN74ALVCH162525
18-BIT REGISTERED BUS TRANSCEIVER
WITH 3-STATE OUTPUTS

SCES058F – NOVEMBER 1995 – REVISED SEPTEMBER 1999

logic diagram (positive logic)



SN74ALVCH162525
18-BIT REGISTERED BUS TRANSCEIVER
WITH 3-STATE OUTPUTS

SCES058F – NOVEMBER 1995 – REVISED SEPTEMBER 1999

recommended operating conditions (see Note 4)

		MIN	MAX	UNIT
V _{CC}	Supply voltage	1.65	3.6	V
V _{IH}	High-level input voltage	V _{CC} = 1.65 V to 1.95 V	0.65 × V _{CC}	V
		V _{CC} = 2.3 V to 2.7 V	1.7	
		V _{CC} = 2.7 V to 3.6 V	2	
V _{IL}	Low-level input voltage	V _{CC} = 1.65 V to 1.95 V	0.35 × V _{CC}	V
		V _{CC} = 2.3 V to 2.7 V	0.7	
		V _{CC} = 2.7 V to 3.6 V	0.8	
V _I	Input voltage	0	V _{CC}	V
V _O	Output voltage	0	V _{CC}	V
I _{OH}	High-level output current (A port)	V _{CC} = 1.65 V	-4	mA
		V _{CC} = 2.3 V	-12	
		V _{CC} = 2.7 V	-12	
		V _{CC} = 3 V	-24	
	High-level output current (B port)	V _{CC} = 1.65 V	-2	
		V _{CC} = 2.3 V	-6	
		V _{CC} = 2.7 V	-8	
		V _{CC} = 3 V	-12	
I _{OL}	Low-level output current (A port)	V _{CC} = 1.65 V	4	mA
		V _{CC} = 2.3 V	12	
		V _{CC} = 2.7 V	12	
		V _{CC} = 3 V	24	
	Low-level output current (B port)	V _{CC} = 1.65 V	2	
		V _{CC} = 2.3 V	6	
		V _{CC} = 2.7 V	8	
		V _{CC} = 3 V	12	
Δt/Δv	Input transition rise or fall rate		10	ns/V
T _A	Operating free-air temperature	-40	85	°C

NOTE 4: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



SN74ALVCH162525
18-BIT REGISTERED BUS TRANSCEIVER
WITH 3-STATE OUTPUTS

SCES058F – NOVEMBER 1995 – REVISED SEPTEMBER 1999

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V _{CC}	MIN	TYP†	MAX	UNIT
V _{OH}	A port	I _{OH} = -100 μA	1.65 V to 3.6 V	V _{CC} -0.2			V
		I _{OH} = -4 mA	1.65 V	1.2			
		I _{OH} = -6 mA	2.3 V	2			
		I _{OH} = -12 mA	2.3 V	1.7			
			2.7 V	2.2			
			3 V	2.4			
	I _{OH} = -24 mA	3 V	2				
	B port	I _{OH} = -100 μA	1.65 V to 3.6 V	V _{CC} -0.2			
		I _{OH} = -2 mA	1.65 V	1.2			
		I _{OH} = -4 mA	2.3 V	1.9			
		I _{OH} = -6 mA	2.3 V	1.7			
			3 V	2.4			
		I _{OH} = -8 mA	2.7 V	2			
		I _{OH} = -12 mA	3 V	2			
V _{OL}	A port	I _{OL} = 100 μA	1.65 V to 3.6 V			0.2	V
		I _{OL} = 4 mA	1.65 V			0.45	
		I _{OL} = 6 mA	2.3 V			0.4	
		I _{OL} = 12 mA	2.3 V			0.7	
			2.7 V			0.4	
		I _{OL} = 24 mA	3 V			0.55	
	B port	I _{OL} = 100 μA	1.65 V to 3.6 V			0.2	
		I _{OL} = 2 mA	1.65 V			0.45	
		I _{OL} = 4 mA	2.3 V			0.4	
		I _{OL} = 6 mA	2.3 V			0.55	
			3 V			0.55	
		I _{OL} = 8 mA	2.7 V			0.6	
		I _{OL} = 12 mA	3 V			0.8	
	I _I	V _I = V _{CC} or GND	3.6 V			±5	
I _I (hold)	V _I = 0.58 V	1.65 V	25		μA		
	V _I = 1.07 V		-25				
	V _I = 0.7 V	2.3 V	45				
	V _I = 1.7 V		-45				
	V _I = 0.8 V	3 V	75				
	V _I = 2 V		-75				
	V _I = 0 to 3.6 V‡	3.6 V	±500				
I _{OZ} §	V _O = V _{CC} or GND	3.6 V			±10	μA	
I _{CC}	V _I = V _{CC} or GND, I _O = 0	3.6 V			40	μA	
ΔI _{CC}	One input at V _{CC} - 0.6 V, Other inputs at V _{CC} or GND	3 V to 3.6 V			750	μA	
C _i	Control inputs	V _I = V _{CC} or GND	3.3 V	3		pF	
C _{io}	A or B ports	V _O = V _{CC} or GND	3.3 V	7		pF	

† All typical values are at V_{CC} = 3.3 V, T_A = 25°C.

‡ This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

§ For I/O ports, the parameter I_{OZ} includes the input leakage current.



SN74ALVCH162525

18-BIT REGISTERED BUS TRANSCEIVER WITH 3-STATE OUTPUTS

SCES058F – NOVEMBER 1995 – REVISED SEPTEMBER 1999

timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 through 3)

		V _{CC} = 1.8 V		V _{CC} = 2.5 V ± 0.2 V		V _{CC} = 2.7 V		V _{CC} = 3.3 V ± 0.3 V		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
f _{clock}	Clock frequency	†		120		125		150		MHz
t _w	Pulse duration, CLK high or low	†		3.2		3.2		3		ns
t _{su}	Setup time	A data before CLKAB↑		†		1.3		1.3		ns
		B data before CLK2BA↑		†		2.1		1.8		
		B data before CLK1BA↑		†		1.3		1.2		
		SEL before CLK2BA↑		†		3.3		3.3		
		CLKENAB before CLKAB↑		†		2.1		1.9		
		CLKENBA before CLK1BA↑		†		2.7		2.5		
t _h	Hold time	A data after CLKAB↑		†		0.7		0.4		ns
		B data after CLK2BA↑		†		0.4		0		
		B data after CLK1BA↑		†		0.8		0.4		
		SEL after CLK2BA↑		†		0		0		
		CLKENAB after CLKAB↑		†		0.1		0.3		
		CLKENBA after CLK1BA↑		†		0		0		
CLKENBA after CLK2BA↑		†		0		0		0		

† This information was not available at the time of publication.

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 through 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 1.8 V		V _{CC} = 2.5 V ± 0.2 V		V _{CC} = 2.7 V		V _{CC} = 3.3 V ± 0.3 V		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
f _{max}			†		120		125		150		MHz
t _{pd}	CLKAB	B		†	1	5.5	5.4		1	4.7	ns
	CLK2BA	A		†	1	4.5	4.4		1	4.2	
t _{en}	OEBA	A		†	1	6.1	6.1		1	5.1	ns
	OEAB	B		†	1	6.7	6.8		1	5.7	
t _{dis}	OEBA	A		†	1	6.3	5.4		1	4.9	ns
	OEAB	B		†	1	6.3	5.4		1	4.9	

† This information was not available at the time of publication.

operating characteristics, T_A = 25°C

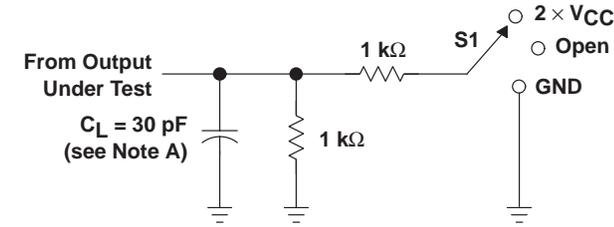
PARAMETER		TEST CONDITIONS	V _{CC} = 1.8 V	V _{CC} = 2.5 V	V _{CC} = 3.3 V	UNIT	
			TYP	TYP	TYP		
C _{pd}	Power dissipation capacitance	Outputs enabled Outputs disabled	CL = 50 pF, f = 10 MHz	†	160	160	pF
				†	160	160	

† This information was not available at the time of publication.

SN74ALVCH162525
18-BIT REGISTERED BUS TRANSCEIVER
WITH 3-STATE OUTPUTS

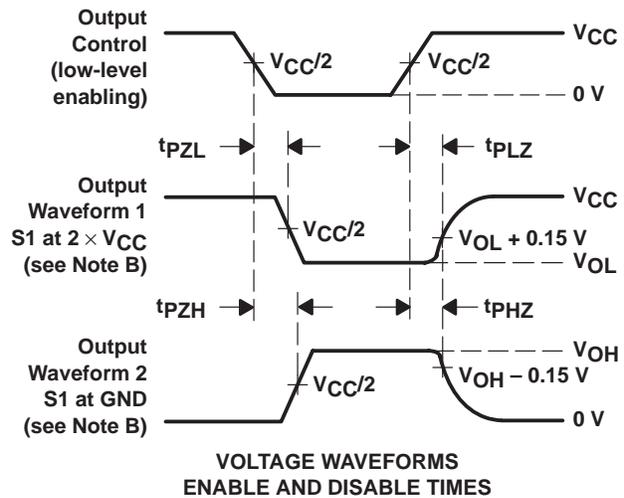
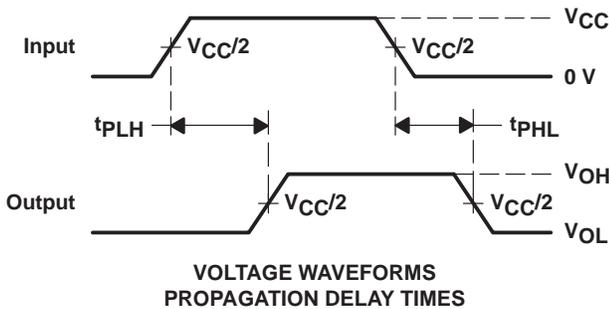
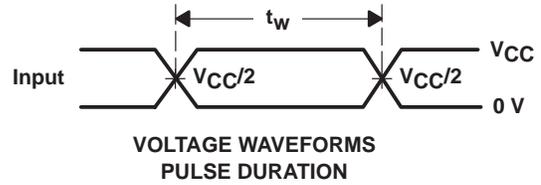
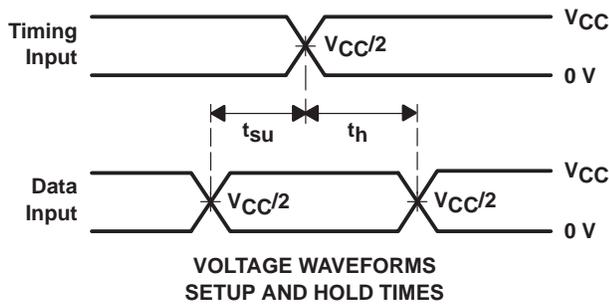
SCES058F – NOVEMBER 1995 – REVISED SEPTEMBER 1999

PARAMETER MEASUREMENT INFORMATION
 $V_{CC} = 1.8\text{ V}$



LOAD CIRCUIT

TEST	S1
t_{pd}	Open
t_{PLZ}/t_{PZL}	$2 \times V_{CC}$
t_{PHZ}/t_{PHL}	GND

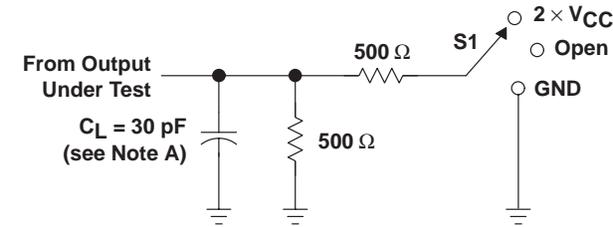


- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 2\text{ ns}$, $t_f \leq 2\text{ ns}$.
 - D. The outputs are measured one at a time with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en} .
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 1. Load Circuit and Voltage Waveforms

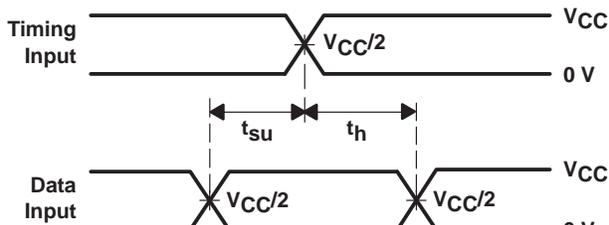
PARAMETER MEASUREMENT INFORMATION

$V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$

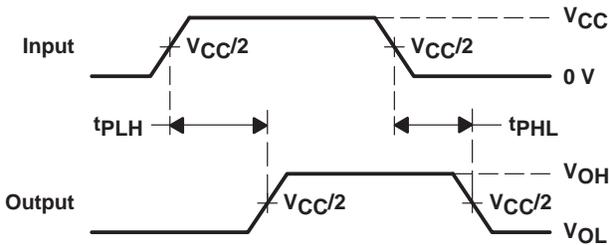


LOAD CIRCUIT

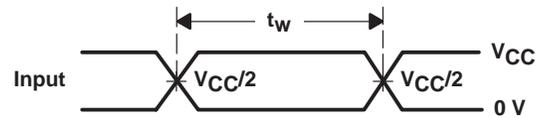
TEST	S1
t_{pd}	Open
t_{PLZ}/t_{PZL}	2 $\times V_{CC}$
t_{PHZ}/t_{PZH}	GND



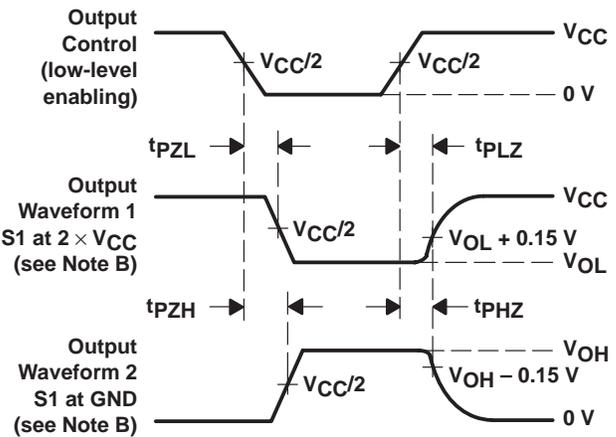
VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES

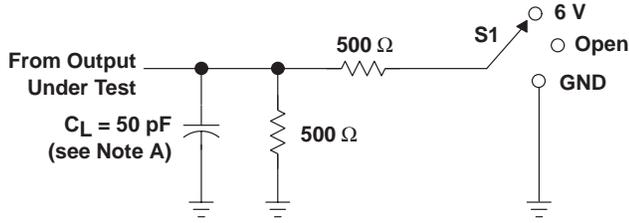
- NOTES: A. C_L includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: PRR $\leq 10\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 2\text{ ns}$, $t_f \leq 2\text{ ns}$.
D. The outputs are measured one at a time with one transition per measurement.
E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
F. t_{PZL} and t_{PZH} are the same as t_{en} .
G. t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 2. Load Circuit and Voltage Waveforms

SN74ALVCH162525
18-BIT REGISTERED BUS TRANSCEIVER
WITH 3-STATE OUTPUTS

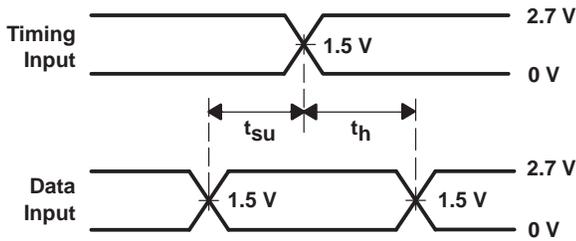
SCES058F – NOVEMBER 1995 – REVISED SEPTEMBER 1999

PARAMETER MEASUREMENT INFORMATION
 $V_{CC} = 2.7\text{ V AND } 3.3\text{ V} \pm 0.3\text{ V}$

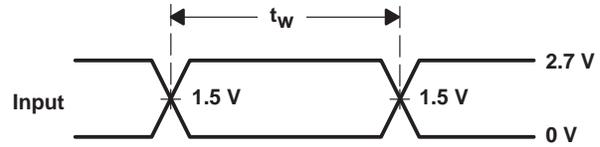


LOAD CIRCUIT

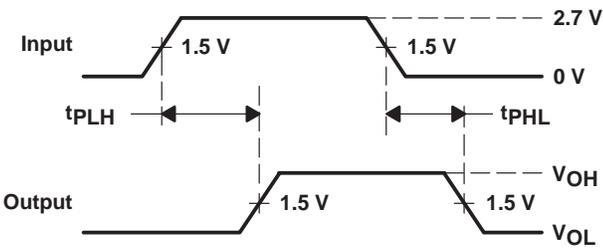
TEST	S1
t_{pd}	Open
t_{PLZ}/t_{PZL}	6 V
t_{PHZ}/t_{PZH}	GND



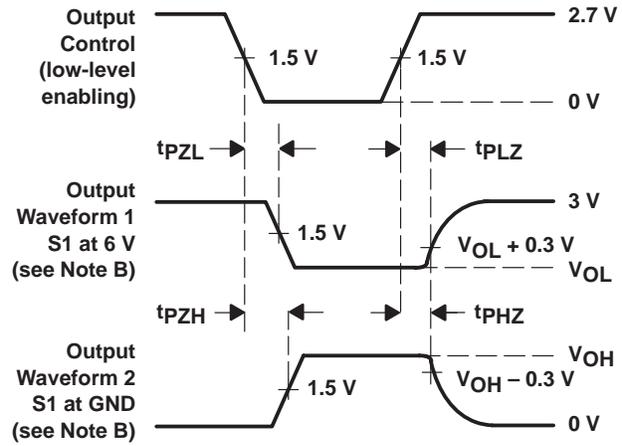
**VOLTAGE WAVEFORMS
 SETUP AND HOLD TIMES**



**VOLTAGE WAVEFORMS
 PULSE DURATION**



**VOLTAGE WAVEFORMS
 PROPAGATION DELAY TIMES**



**VOLTAGE WAVEFORMS
 ENABLE AND DISABLE TIMES**

- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 2.5\text{ ns}$, $t_f \leq 2.5\text{ ns}$.
 D. The outputs are measured one at a time with one transition per measurement.
 E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 F. t_{PZL} and t_{PZH} are the same as t_{en} .
 G. t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 3. Load Circuit and Voltage Waveforms

IMPORTANT NOTICE

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgement, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its semiconductor products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

CERTAIN APPLICATIONS USING SEMICONDUCTOR PRODUCTS MAY INVOLVE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE ("CRITICAL APPLICATIONS"). TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS. INCLUSION OF TI PRODUCTS IN SUCH APPLICATIONS IS UNDERSTOOD TO BE FULLY AT THE CUSTOMER'S RISK.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, warranty or endorsement thereof.